

**AMENDMENTS TO THE SPECIFICATION**

Please delete the section heading at page 1, line 1.

Please replace the section heading at page 4, line 3 with the following rewritten heading:

-- ~~DISCLOSURE~~SUMMARY OF THE INVENTION --

Please replace the paragraph at page 8, line 16 with the following rewritten paragraph:

-- Fig. 4 illustrates a step of the process for processing a semiconductor wafer according to the present invention; ~~wherein:~~ --

Please delete lines 19-24 on page 8.

Please delete lines 1-4 on page 9.

Please replace the section heading at page 9, line 6 with the following rewritten heading:

-- ~~PREFERRED EMBODIMENTS~~DETAILED DESCRIPTION OF THE INVENTION --

Please delete the section heading on page 29, line 3.